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PATENT  
DT04 Rec'd PCT/PTO 15 SEP 2004

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No. : National Phase Appl. of PCT/EP03/02627  
filed on March 15, 2003  
Applicant : Dietmar BIRGEL  
Filed : September 15, 2004  
Title : Method for populating and soldering a circuit board,  
reflow oven and circuit board for such a method  
TC/A.U. :  
Examiner :  
Docket No. : BIRG3004/FJD  
Customer No. : 23364

**PRELIMINARY AMENDMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

**Introductory Comments**

Please amend this application before examination on the merits in accordance with the following particulars.

Prior to calculation of the filing fee and examination of the application, please amend the claims as shown in the following LIST OF CURRENT CLAIMS, which indicates the status of all the claims in the application and all amendments to the claims. Any cancellation of claims is made without prejudice or disclaimer. Applicant reserves all rights to the original disclosed and claimed subject matter.

**Amendments to the Specification** begin on page 2 of this paper.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 3 of this paper.

**Amendments to the Abstract** begin on page 12 of this paper.